

# IRS2183/IRS21834(S)PbF

## HALF-BRIDGE DRIVER

### Features

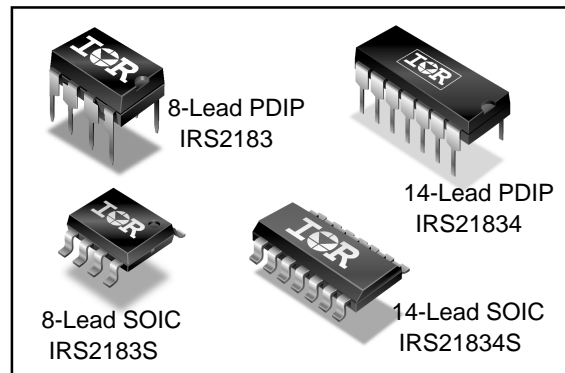
- Floating channel designed for bootstrap operation
- Fully operational to +600 V
- Tolerant to negative transient voltage,  $dV/dt$  immune
- Gate drive supply range from 10 V to 20 V
- Undervoltage lockout for both channels
- 3.3 V and 5 V input logic compatible
- Matched propagation delay for both channels
- Logic and power ground +/- 5 V offset
- Lower  $di/dt$  gate driver for better noise immunity
- Output source/sink current capability 1.4 A/1.8 A
- RoHS compliant

### Description

The IRS2183/IRS21834 are high voltage, high speed power MOSFET and IGBT drivers with dependent high-side and low-side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3 V logic. The output drivers feature a high pulse current buffer stage designed for minimum

driver cross-conduction. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high-side configuration which operates up to 600 V.

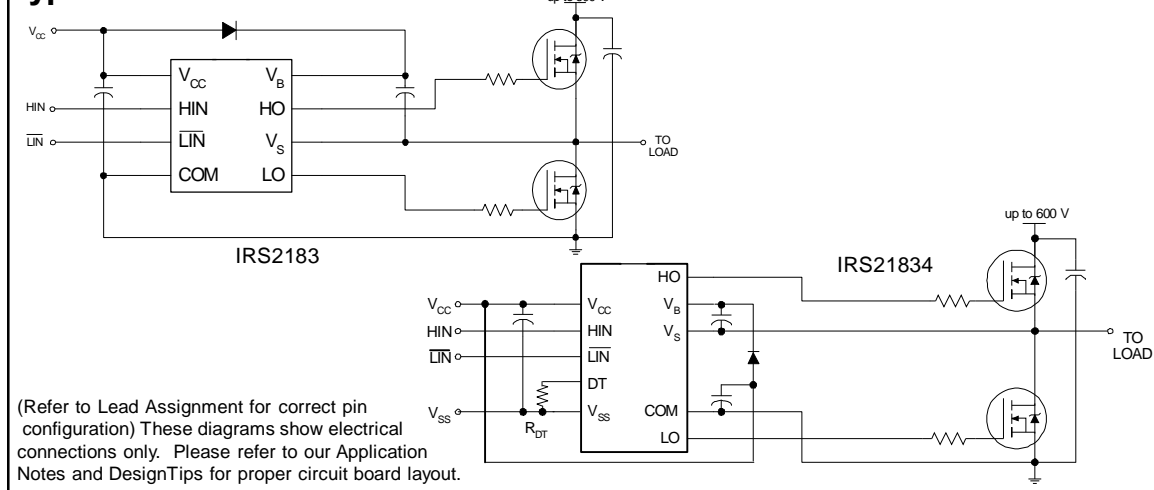
### Packages



### Feature Comparison

Part	Input logic	Cross-conduction prevention logic	Deadtime (ns)	Ground Pins	$t_{on}/t_{off}$ (ns)
2181	HIN/LIN	no	none	COM	180/220
21814				$V_{SS}/COM$	
2183	HIN/ $\overline{LIN}$	yes	Internal 400 Program 400-5000	COM	180/220
21834				$V_{SS}/COM$	
2184	IN/ $\overline{SD}$	yes	Internal 400 Program 400-5000	COM	680/270
21844				$V_{SS}/COM$	

### Typical Connection



## Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units	
V <sub>B</sub>	High-side floating absolute voltage	-0.3	620 (Note 1)	V	
V <sub>S</sub>	High-side floating supply offset voltage	V <sub>B</sub> - 20	V <sub>B</sub> + 0.3		
V <sub>HO</sub>	High-side floating output voltage	V <sub>S</sub> - 0.3	V <sub>B</sub> + 0.3		
V <sub>CC</sub>	Low-side and logic fixed supply voltage	-0.3	20 (Note 1)		
V <sub>LO</sub>	Low-side output voltage	-0.3	V <sub>CC</sub> + 0.3		
DT	Programmable deadtime pin voltage (IR21834 only)	V <sub>SS</sub> - 0.3	V <sub>CC</sub> + 0.3		
V <sub>IN</sub>	Logic input voltage (HIN & LIN)	V <sub>SS</sub> - 0.3	V <sub>CC</sub> + 0.3		
V <sub>SS</sub>	Logic ground (IR21834 only)	V <sub>CC</sub> - 20	V <sub>CC</sub> + 0.3		
dV <sub>S</sub> /dt	Allowable offset supply voltage transient	—	50	V/ns	
P <sub>D</sub>	Package power dissipation @ T <sub>A</sub> ≤ +25 °C	(8-lead PDIP)	—	1.0	W
		(8-lead SOIC)	—	0.625	
		(14-lead PDIP)	—	1.6	
		(14-lead SOIC)	—	1.0	
R <sub>thJA</sub>	Thermal resistance, junction to ambient	(8-lead PDIP)	—	125	°C/W
		(8-lead SOIC)	—	200	
		(14-lead PDIP)	—	75	
		(14-lead SOIC)	—	120	
T <sub>J</sub>	Junction temperature	—	150	°C	
T <sub>S</sub>	Storage temperature	-50	150		
T <sub>L</sub>	Lead temperature (soldering, 10 seconds)	—	300		

Note 1: All supplies are fully tested at 25 V and an internal 20 V clamp exists for each supply.

## Recommended Operating Conditions

The input/output logic timing diagram is shown in Fig. 1. For proper operation the device should be used within the recommended conditions. The V<sub>S</sub> and V<sub>SS</sub> offset rating are tested with all supplies biased at 15 V differential.

Symbol	Definition	Min.	Max.	Units
V <sub>B</sub>	High-side floating supply absolute voltage	V <sub>S</sub> + 10	V <sub>S</sub> + 20	V
V <sub>S</sub>	High-side floating supply offset voltage	Note 2	600	
V <sub>HO</sub>	High-side floating output voltage	V <sub>S</sub>	V <sub>B</sub>	
V <sub>CC</sub>	Low-side and logic fixed supply voltage	10	20	
V <sub>LO</sub>	Low-side output voltage	0	V <sub>CC</sub>	
V <sub>IN</sub>	Logic input voltage (HIN & LIN)	V <sub>SS</sub>	V <sub>CC</sub>	
DT	Programmable deadtime pin voltage (IR21834 only)	V <sub>SS</sub>	V <sub>CC</sub>	
V <sub>SS</sub>	Logic ground (IR21834 only)	-5	5	
T <sub>A</sub>	Ambient temperature	-40	125	°C

Note 2: Logic operational for V<sub>S</sub> of -5 V to +600 V. Logic state held for V<sub>S</sub> of -5 V to -V<sub>BS</sub>. (Please refer to the Design Tip DT97-3 for more details).

## Dynamic Electrical Characteristics

$V_{BIAS}$  ( $V_{CC}$ ,  $V_{BS}$ ) = 15 V,  $V_{SS}$  = COM,  $C_L$  = 1000 pF,  $T_A$  = 25 °C,  $DT$  =  $V_{SS}$  unless otherwise specified.

Symbol	Definition	Min.	Typ.	Max.	Units	Test Conditions
$t_{on}$	Turn-on propagation delay	—	180	270	ns	$V_S = 0V$
$t_{off}$	Turn-off propagation delay	—	220	330		$V_S = 0V$ or 600V
MT	Delay matching   $t_{on} - t_{off}$	—	0	35		
$t_r$	Turn-on rise time	—	40	60		$V_S = 0V$
$t_f$	Turn-off fall time	—	20	35		
DT	Deadtime: LO turn-off to HO turn-on( $DT_{LO-HO}$ ) & HO turn-off to LO turn-on( $DT_{HO-LO}$ )	280	400	520	$\mu s$	$R_{DT} = 0 \Omega$
		4	5	6		$R_{DT} = 200 k\Omega$ (IR21834)
MDT	Deadtime matching =   $DT_{LO-HO} - DT_{HO-LO}$	—	0	50	ns	$R_{DT} = 0 \Omega$
		—	0	600		$R_{DT} = 200 k\Omega$ (IR21834)

## Static Electrical Characteristics

$V_{BIAS}$  ( $V_{CC}$ ,  $V_{BS}$ ) = 15 V,  $V_{SS}$  = COM,  $DT = V_{SS}$  and  $T_A = 25$  °C unless otherwise specified. The  $V_{IL}$ ,  $V_{IH}$ , and  $I_{IN}$  parameters are referenced to  $V_{SS}/COM$  and are applicable to the respective input leads: HIN and LIN. The  $V_O$ ,  $I_O$ , and  $R_{on}$  parameters are referenced to COM and are applicable to the respective output leads: HO and LO.

Symbol	Definition	Min.	Typ.	Max.	Units	Test Conditions
$V_{IH}$	Logic "1" input voltage for HIN & logic "0" for $\overline{LIN}$	2.5	—	—	V	$V_{CC} = 10V$ to 20 V
$V_{IL}$	Logic "0" input voltage for HIN & logic "1" for $\overline{LIN}$	—	—	0.8		$I_O = 0A$
$V_{OH}$	High level output voltage, $V_{BIAS} - V_O$	—	—	1.4		$I_O = 20mA$
$V_{OL}$	Low level output voltage, $V_O$	—	—	0.2	$\mu A$	$V_B = V_S = 600V$
$I_{LK}$	Offset supply leakage current	—	—	50		$V_{IN} = 0V$ or 5 V
$I_{QBS}$	Quiescent $V_{BS}$ supply current	20	60	150	mA	
$I_{QCC}$	Quiescent $V_{CC}$ supply current	0.4	1.0	1.6		
$I_{IN+}$	Logic "1" input bias current	—	25	60	$\mu A$	$HIN = 5V$ , $\overline{LIN} = 0V$
$I_{IN-}$	Logic "0" input bias current	—	—	5.0		$HIN = 0V$ , $\overline{LIN} = 5V$
$V_{CCUV+}$ $V_{BSUV+}$	$V_{CC}$ and $V_{BS}$ supply undervoltage positive going threshold	8.0	8.9	9.8	V	
$V_{CCUV-}$ $V_{BSUV-}$	$V_{CC}$ and $V_{BS}$ supply undervoltage negative going threshold	7.4	8.2	9.0		
$V_{CCUVH}$ $V_{BSUVH}$	Hysteresis	0.3	0.7	—		
$I_{O+}$	Output high short circuit pulsed current	1.4	1.9	—	A	$V_O = 0V$ , $PW \leq 10 \mu s$
$I_{O-}$	Output low short circuit pulsed current	1.8	2.3	—		$V_O = 15V$ , $PW \leq 10 \mu s$

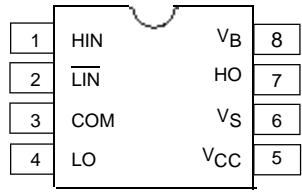
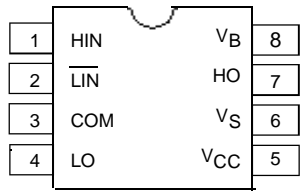
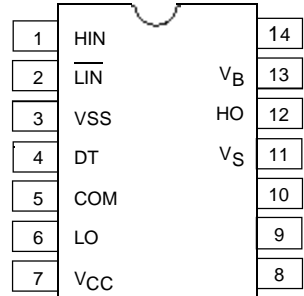
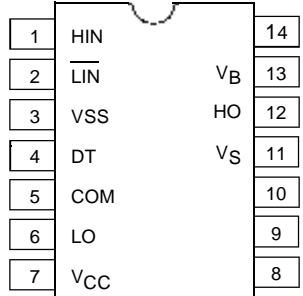
## Functional Block Diagrams



## Lead Definitions

Symbol	Description
HIN	Logic input for high-side gate driver output (HO), in phase (referenced to COM for IRS2183 and VSS for IRS21834)
$\overline{\text{LIN}}$	Logic input for low-side gate driver output (LO), out of phase (referenced to COM for IRS2183 and VSS for IRS21834)
DT	Programmable deadtime lead, referenced to VSS (IRS21834 only)
VSS	Logic ground (IRS21834 only)
V <sub>B</sub>	High-side floating supply
HO	High-side gate driver output
V <sub>S</sub>	High-side floating supply return
V <sub>CC</sub>	Low-side and logic fixed supply
LO	Low-side gate driver output
COM	Low-side return

## Lead Assignments

 <p>8-Lead PDIP</p>	 <p>8-Lead SOIC</p>
<b>IRS2183PbF</b>	<b>IRS2183SPbF</b>
 <p>14-Lead PDIP</p>	 <p>14-Lead SOIC</p>
<b>IRS21834PbF</b>	<b>IRS21834SPbF</b>

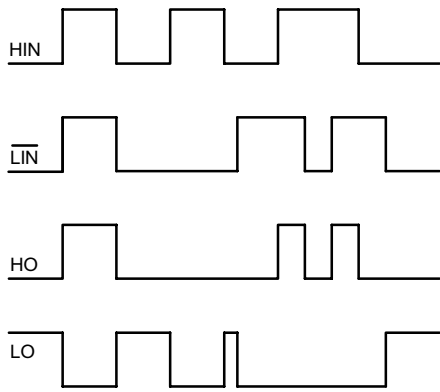


Figure 1. Input/Output Timing Diagram

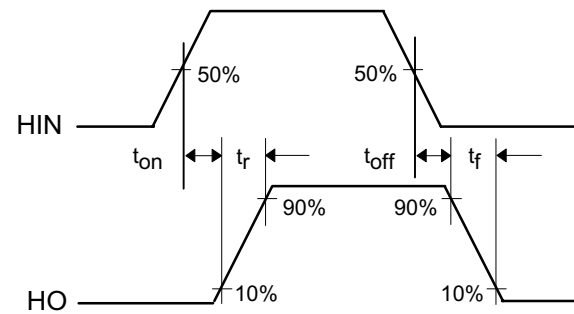
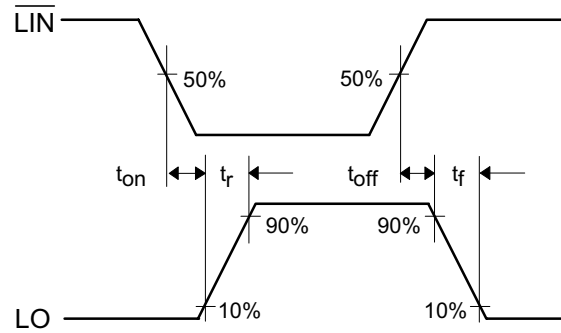


Figure 2. Switching Time Waveform Definitions

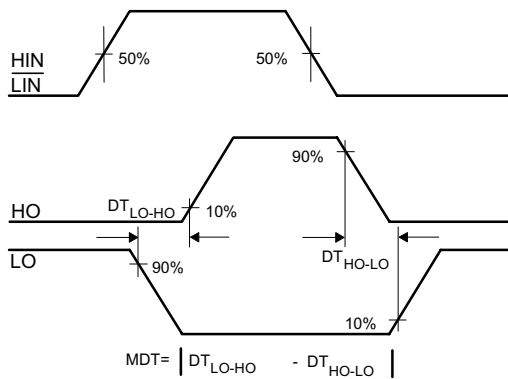
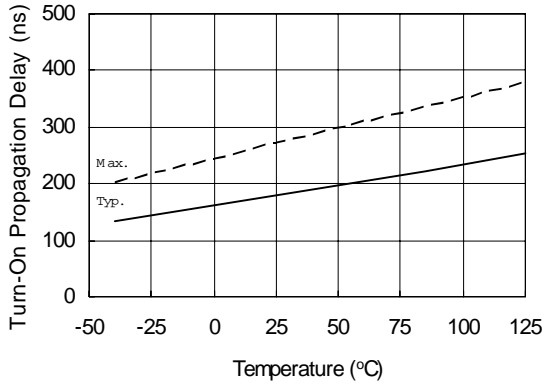
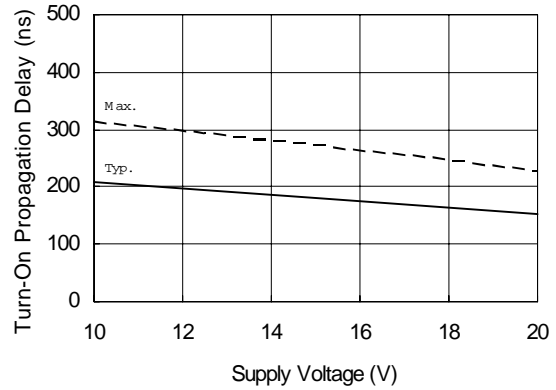


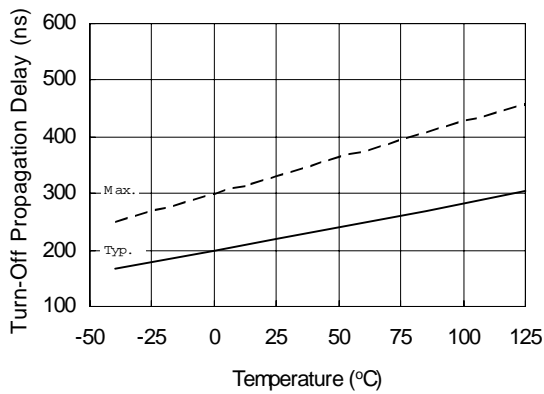
Figure 3. Deadtime Waveform Definitions



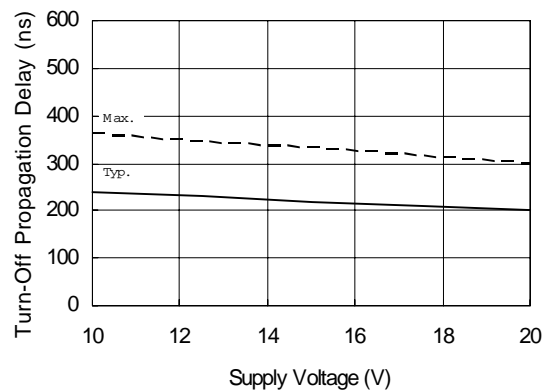
**Figure 4A. Turn-On Propagation Delay vs. Temperature**



**Figure 4B. Turn-On Propagation Delay vs. Supply Voltage**



**Figure 5A. Turn-Off Propagation Delay vs. Temperature**



**Figure 5B. Turn-Off Propagation Delay vs. Supply Voltage**

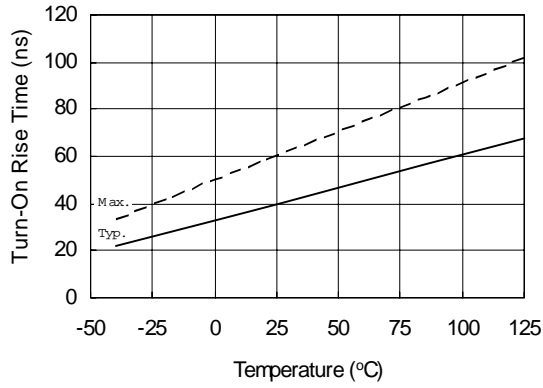


Figure 6A. Turn-On Rise Time vs. Temperature

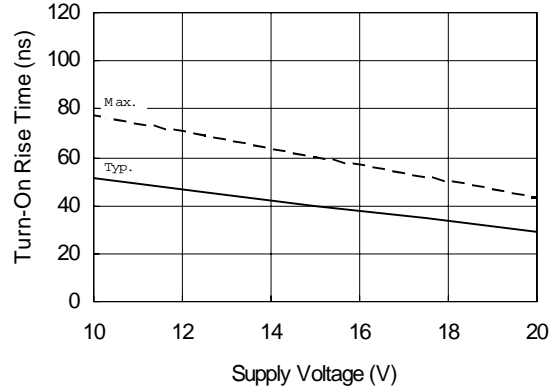


Figure 6B. Turn-On Rise Time vs. Supply Voltage

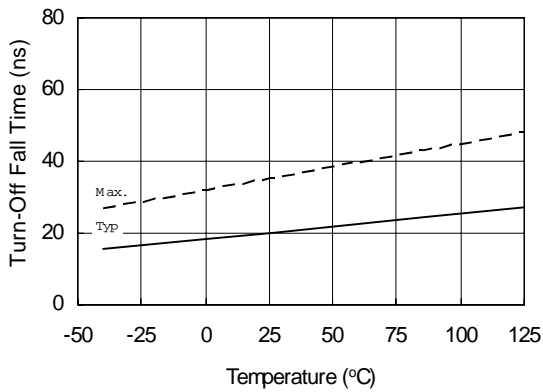


Figure 7A. Turn-Off Fall Time vs. Temperature

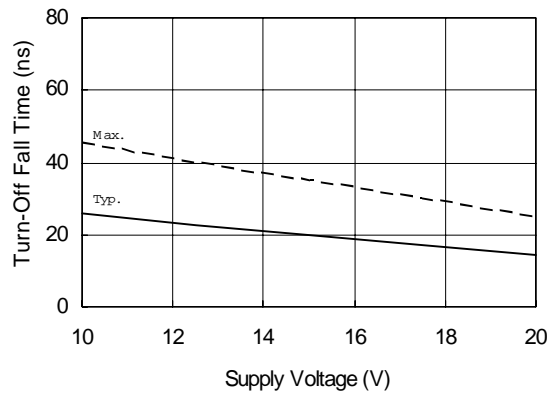


Figure 7B. Turn-Off Fall Time vs. Supply Voltage



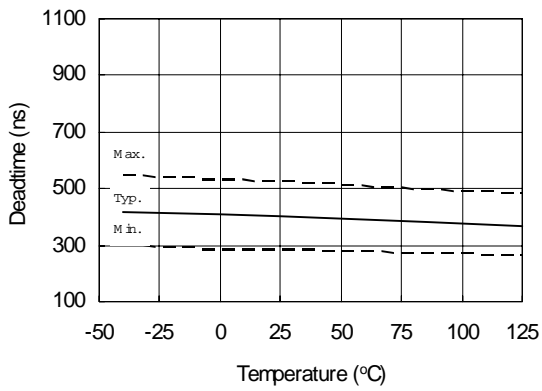


Figure 8A. Deadtime vs. Temperature

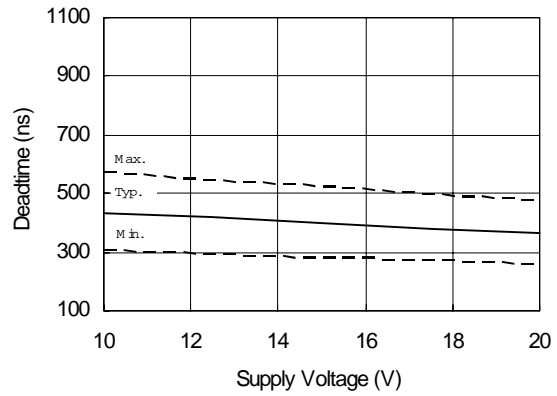


Figure 8B. Deadtime vs. Supply Voltage

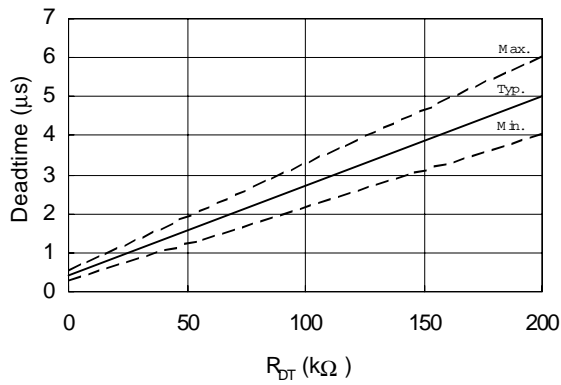


Figure 8C. Deadtime vs. R<sub>DT</sub>

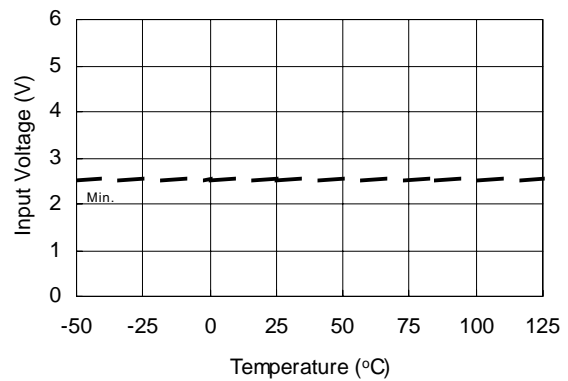
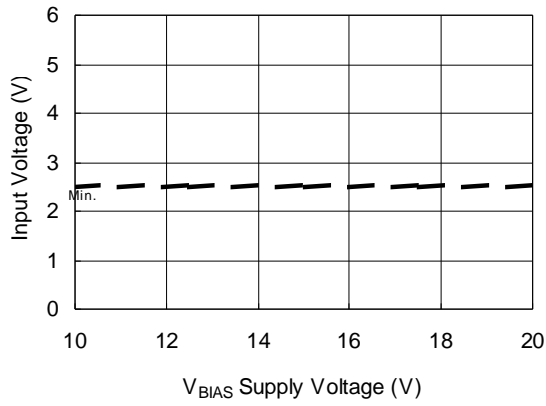
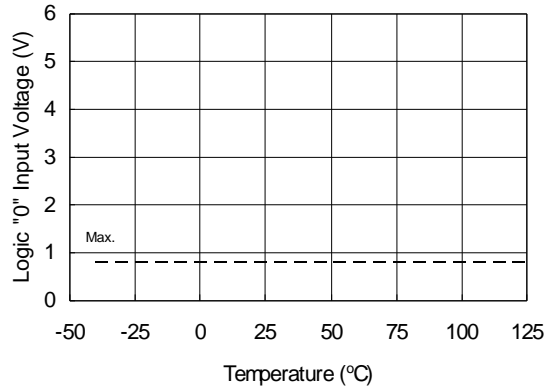


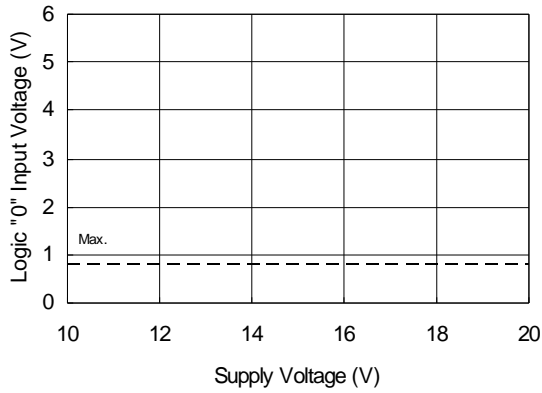
Figure 9A. Logic "1" Input Voltage vs. Temperature



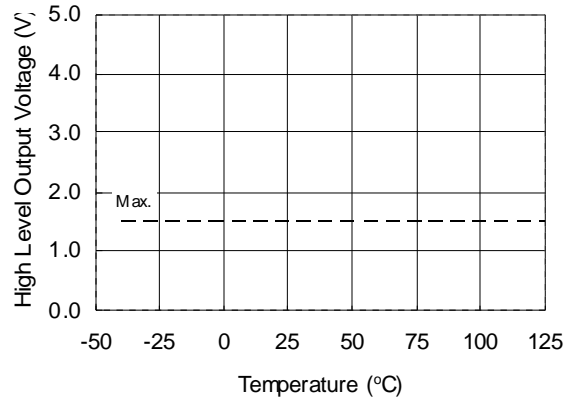
**Figure 9B. Logic "1" Input Voltage vs. Supply Voltage**



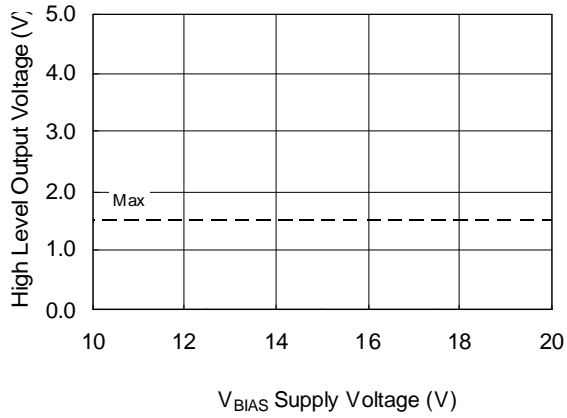
**Figure 10A. Logic "0" Input Voltage vs. Temperature**



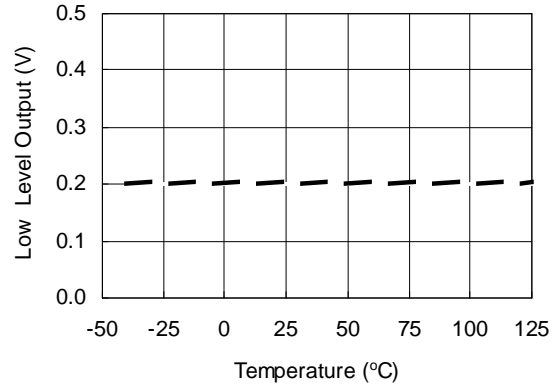
**Figure 10B. Logic "0" Input Voltage vs. Supply Voltage**



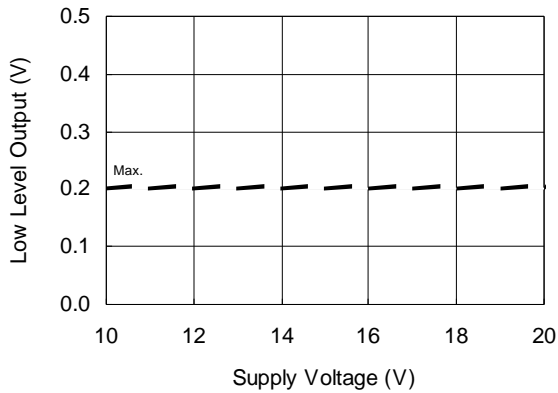
**Figure 11A. High Level Output Voltage vs. Temperature (I<sub>o</sub> = 0 mA)**



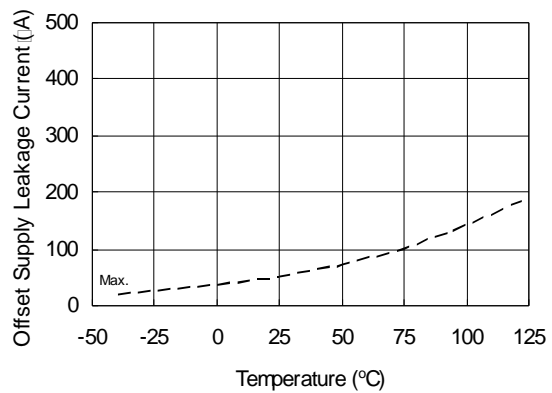
**Figure 11B. High Level Output Voltage vs. Supply Voltage ( $I_o = 0$  mA)**



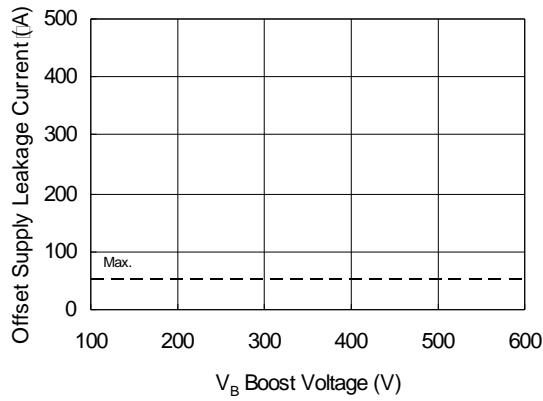
**Figure 12A. Low Level Output vs. Temperature**



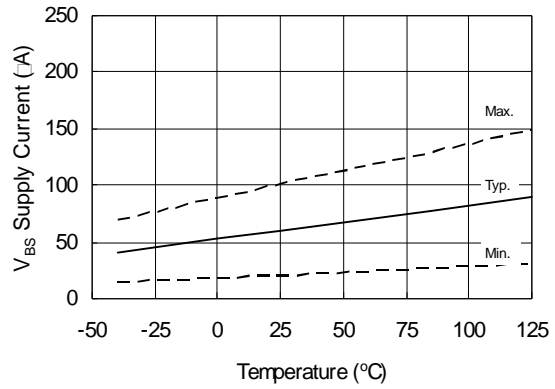
**Figure 12B. Low Level Output vs. Supply Voltage**



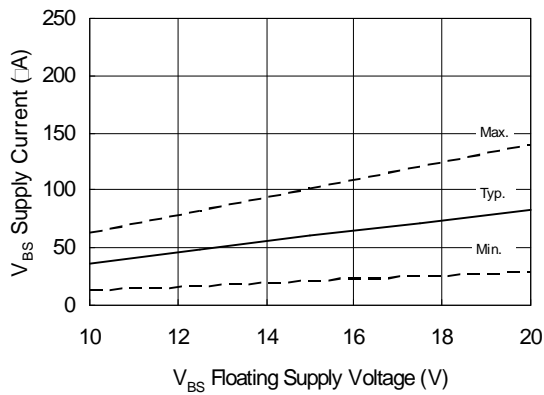
**Figure 13A. Offset Supply Leakage Current vs. Temperature**



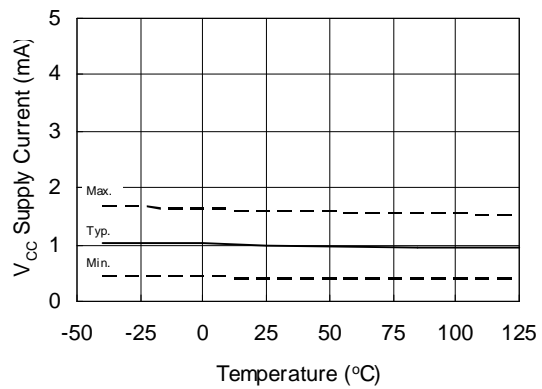
**Figure 13B. Offset Supply Leakage Current vs.  $V_B$  Boost Voltage**



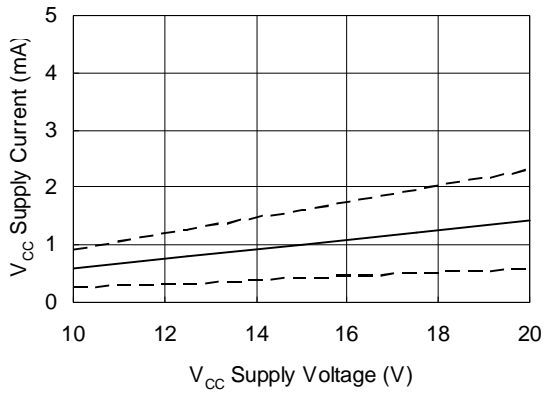
**Figure 14A.  $V_{BS}$  Supply Current vs. Temperature**



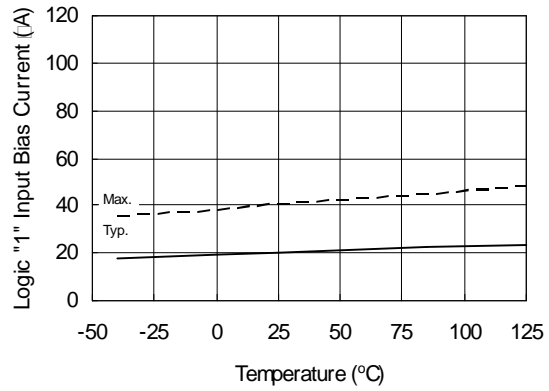
**Figure 14B.  $V_{BS}$  Supply Current vs.  $V_{BS}$  Floating Supply Voltage**



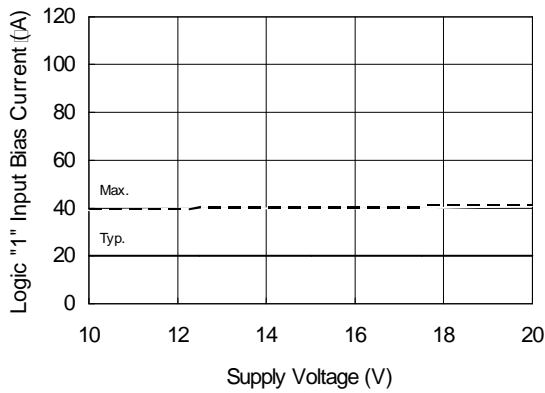
**Figure 15A.  $V_{CC}$  Supply Current vs. Temperature**



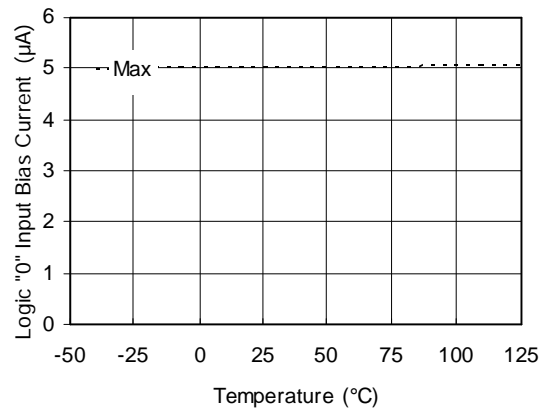
**Figure 15B. V<sub>CC</sub> Supply Current vs. V<sub>CC</sub> Supply Voltage**



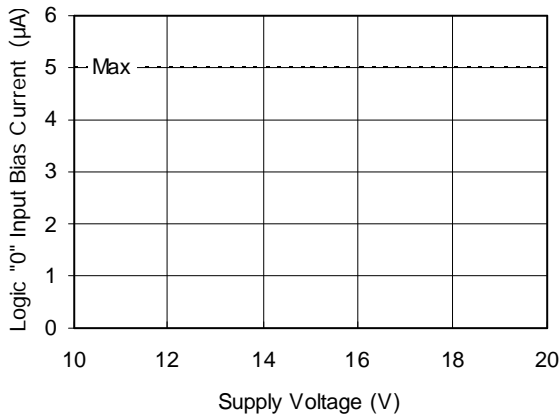
**Figure 16A. Logic "1" Input Bias Current vs. Temperature**



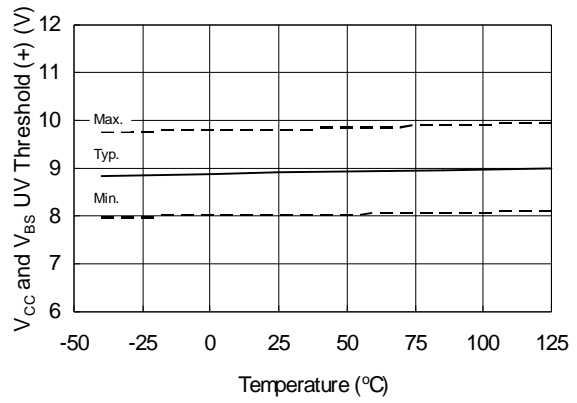
**Figure 16B. Logic "1" Input Bias Current vs. Supply Voltage**



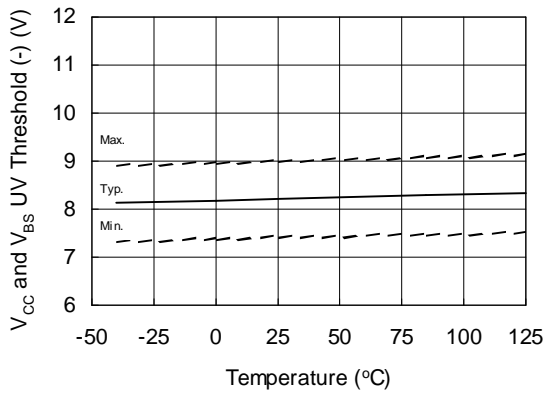
**Figure 17A. Logic "0" Input Bias Current vs. Temperature**



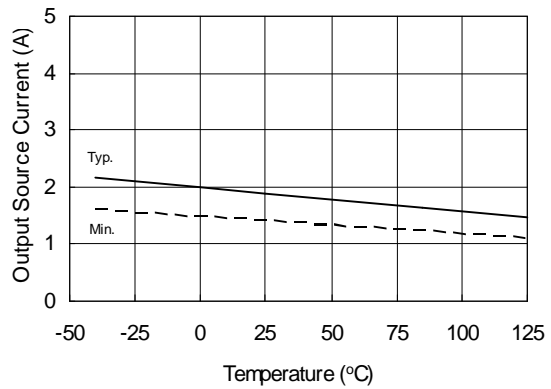
**Figure 17B. Logic "0" Input Bias Current vs. Voltage**



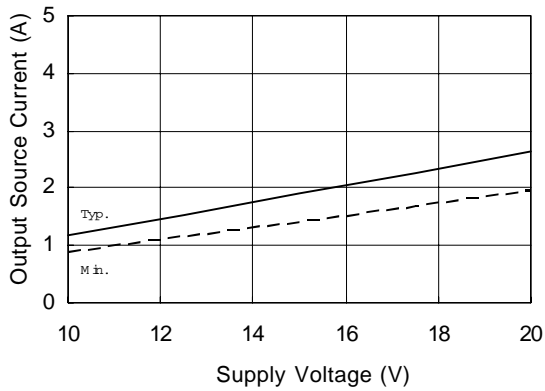
**Figure 18. V<sub>CC</sub> and V<sub>BS</sub> Undervoltage Threshold (+) vs. Temperature**



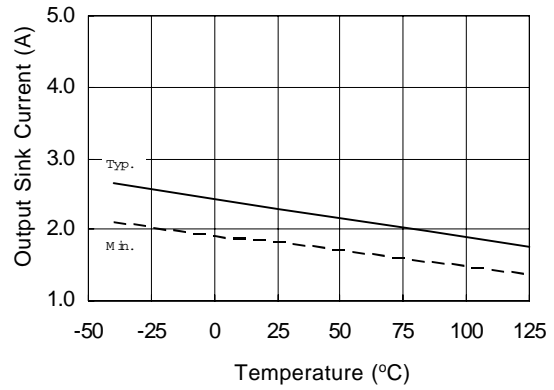
**Figure 19. V<sub>CC</sub> and V<sub>BS</sub> Undervoltage Threshold (-) vs. Temperature**



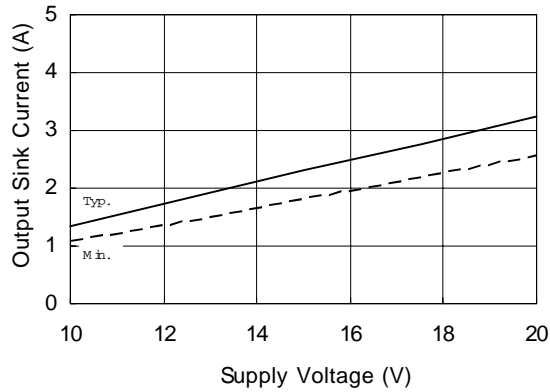
**Figure 20A. Output Source Current vs. Temperature**



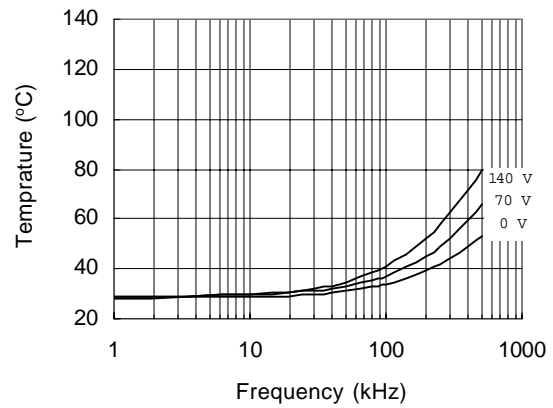
**Figure 20B. Output Source Current vs. Supply Voltage**



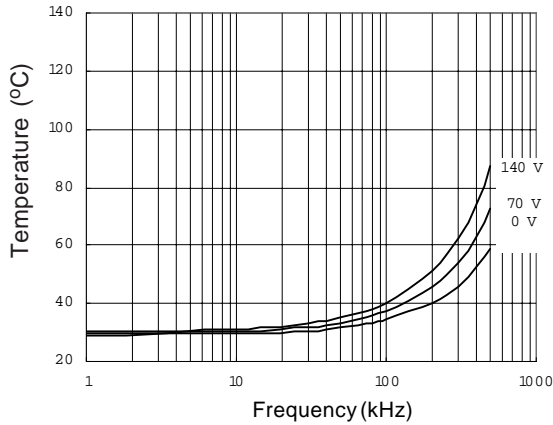
**Figure 21A. Output Sink Current vs. Temperature**



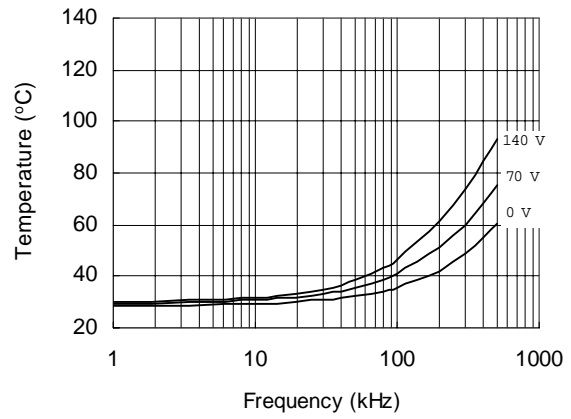
**Figure 21B. Output Sink Current vs. Supply Voltage**



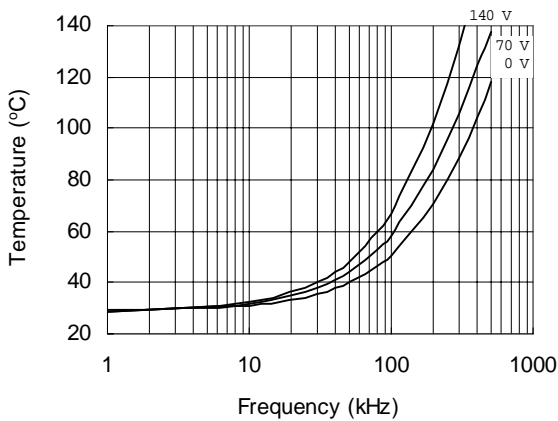
**Figure 22. IRS2183 vs. Frequency (IRFBC20),  
 $R_{gate}=33 \Omega$ ,  $V_{CC}=15 V$**



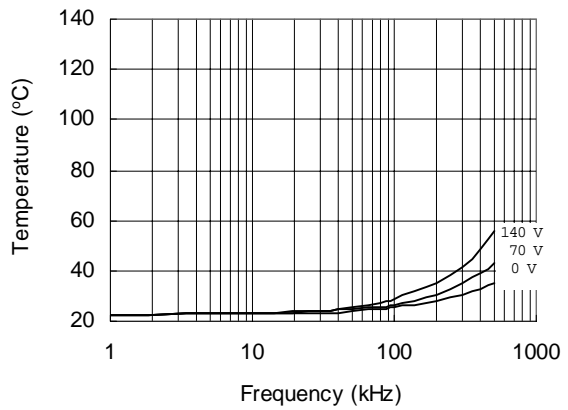
**Figure 23. IRS2183 vs. Frequency (IRFBC30),  
 $R_{gate}=22 \Omega$ ,  $V_{CC}=15 V$**



**Figure 24. IRS2183 vs. Frequency (IRFBC40),  
 $R_{gate}=15 \Omega$ ,  $V_{CC}=15 V$**

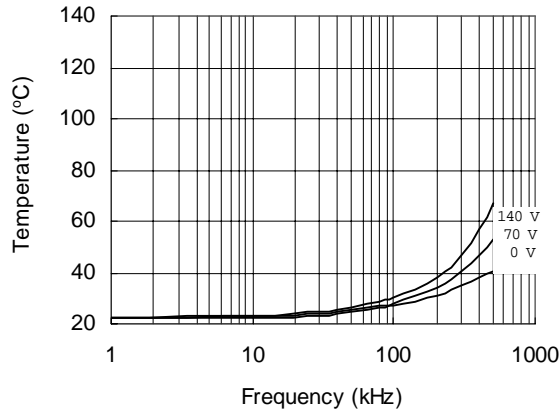


**Figure 25. IRS2183 vs. Frequency (IRFPE50),  
 $R_{gate}=10 \Omega$ ,  $V_{CC}=15 V$**

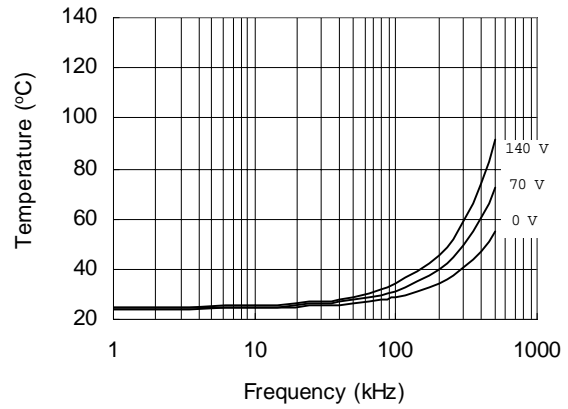


**Figure 26. IRS21834 vs. Frequency (IRFBC20),  
 $R_{gate}=33 \Omega$ ,  $V_{CC}=15 V$**

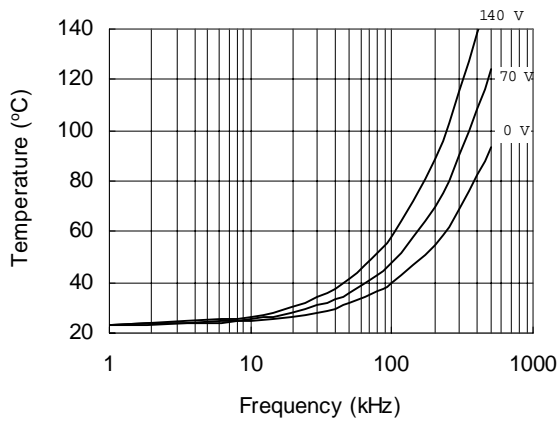




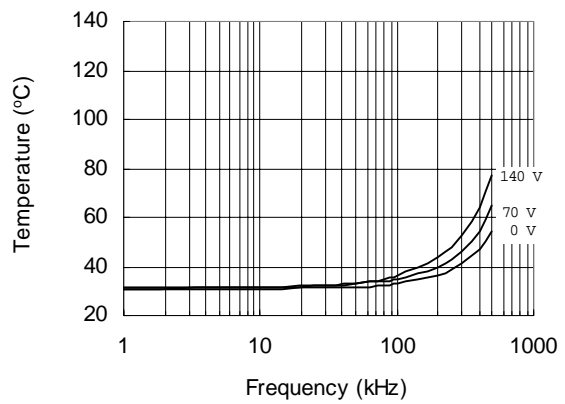
**Figure 27. IRS21834 vs. Frequency (IRFBC30),**  
 $R_{gate}=22 \Omega, V_{CC}=15 V$



**Figure 28. IRS21834 vs. Frequency (IRFBC40),**  
 $R_{gate}=15 \Omega, V_{CC}=15 V$

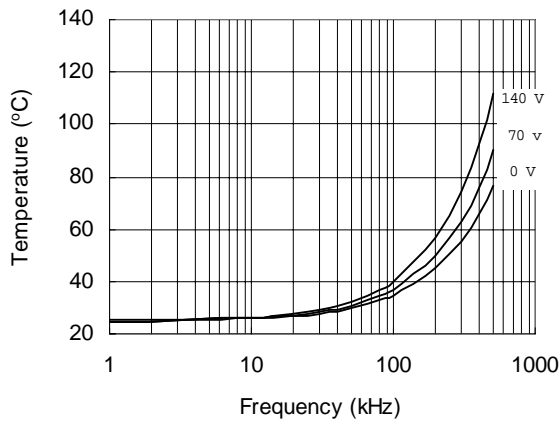


**Figure 29. IRS21834 vs. Frequency (IRFPE50),**  
 $R_{gate}=10 \Omega, V_{CC}=15 V$

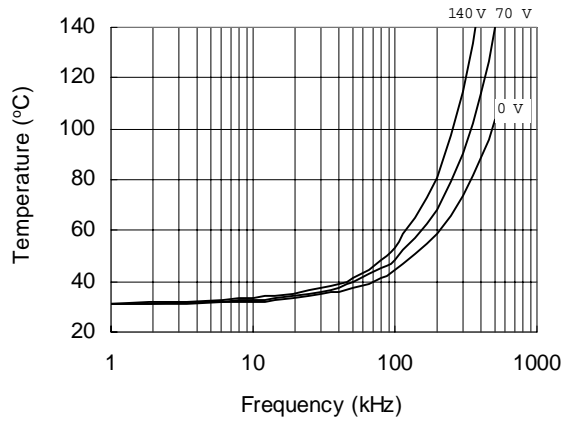


**Figure 30. IRS2183S vs. Frequency (IRFBC20),**  
 $R_{gate}=33 \Omega, V_{CC}=15 V$

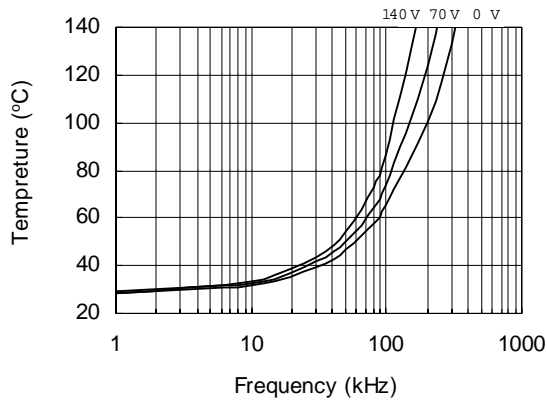
# IRS2183/IRS21834(S)PbF



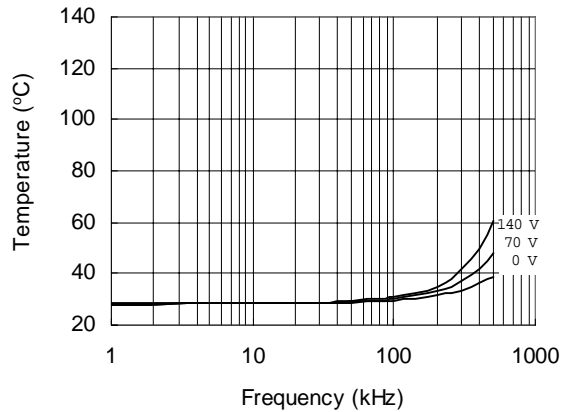
**Figure 31. IRS2183S vs. Frequency (IRFBC30),  
 $R_{gate}=22 \Omega$ ,  $V_{CC}=15 V$**



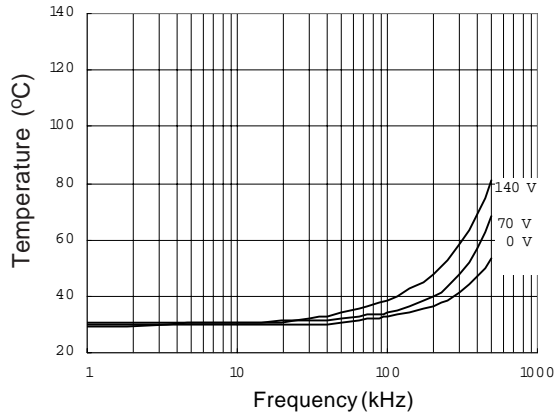
**Figure 32. IRS2183S vs. Frequency (IRFBC40),  
 $R_{gate}=15 \Omega$ ,  $V_{CC}=15 V$**



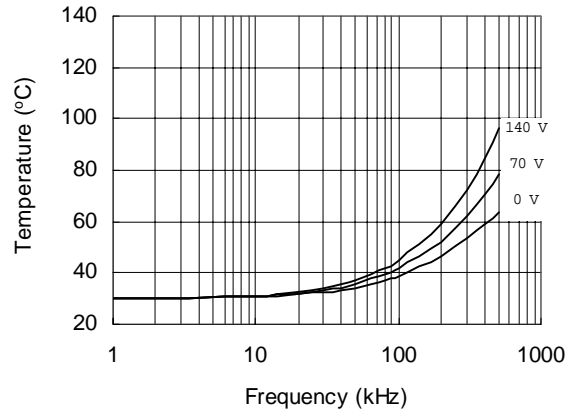
**Figure 33. IRS2183S vs. Frequency (IRFPE50),  
 $R_{gate}=10 \Omega$ ,  $V_{CC}=15 V$**



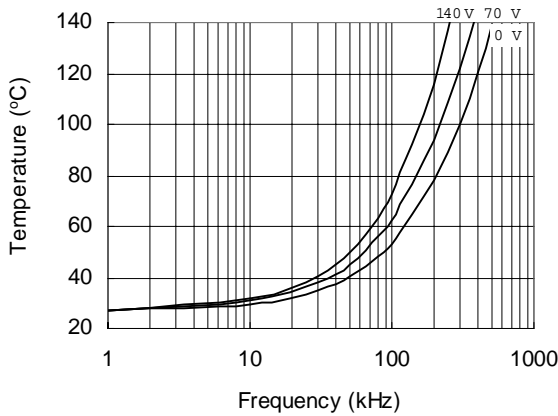
**Figure 34. IRS21834S vs. Frequency (IRFBC20),  
 $R_{gate}=33 \Omega$ ,  $V_{CC}=15 V$**



**Figure 35. IRS21834S vs. Frequency (IRFBC30),**  
 $R_{gate}=22 \Omega, V_{CC}=15 V$

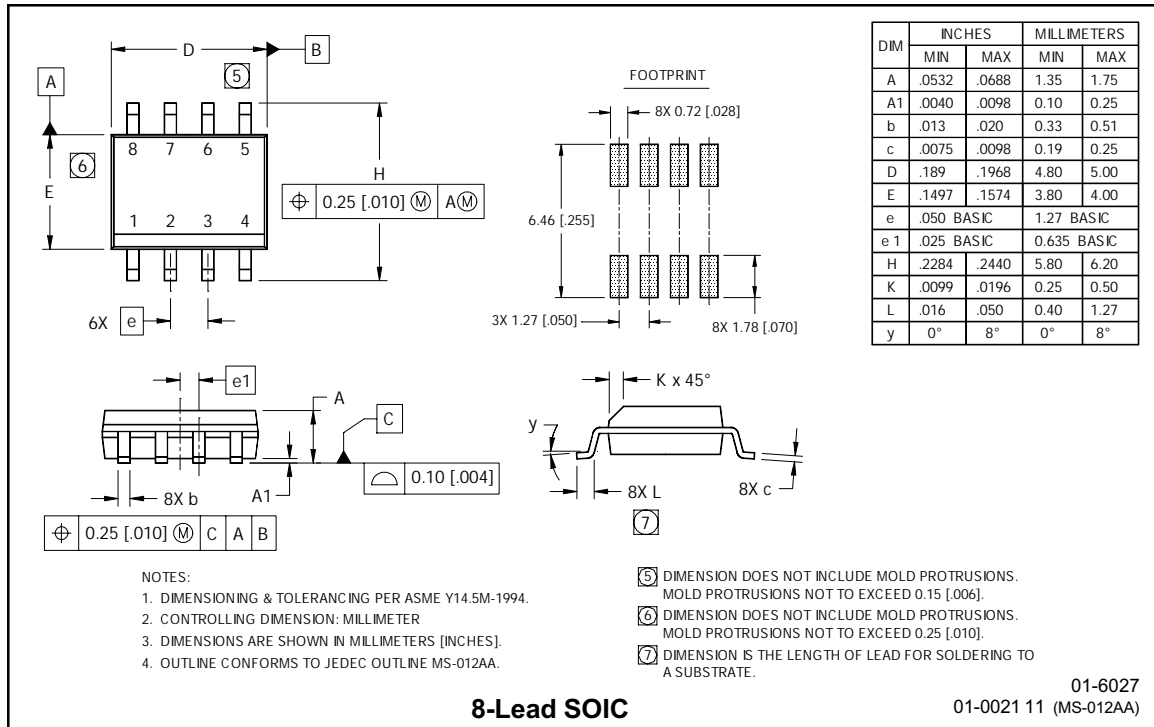
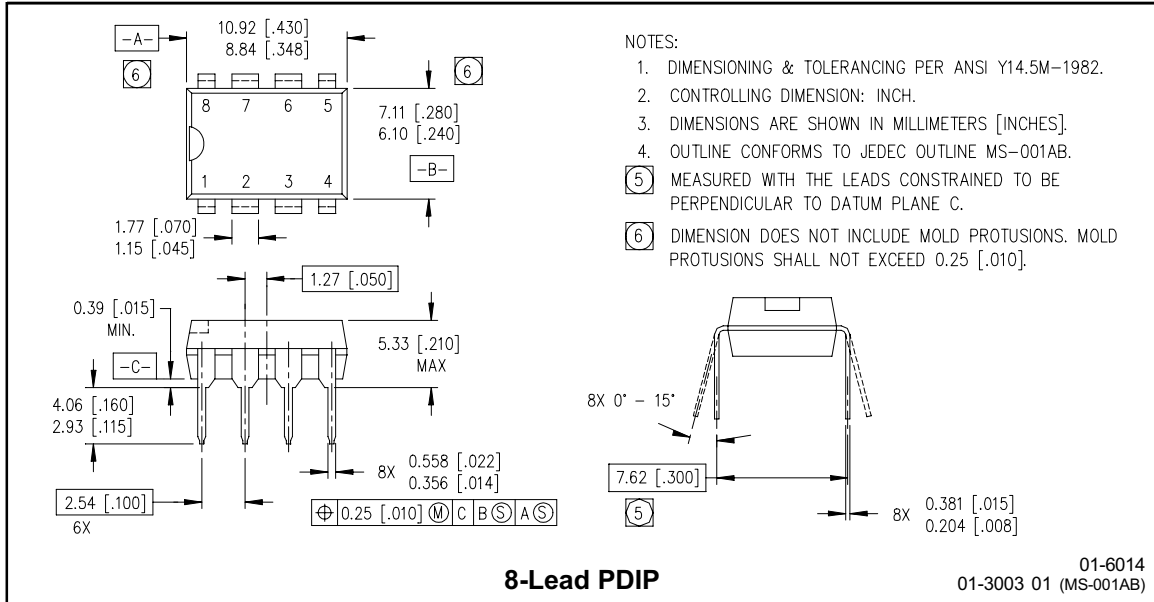


**Figure 36. IRS21834S vs. Frequency (IRFBC40),**  
 $R_{gate}=15 \Omega, V_{CC}=15 V$

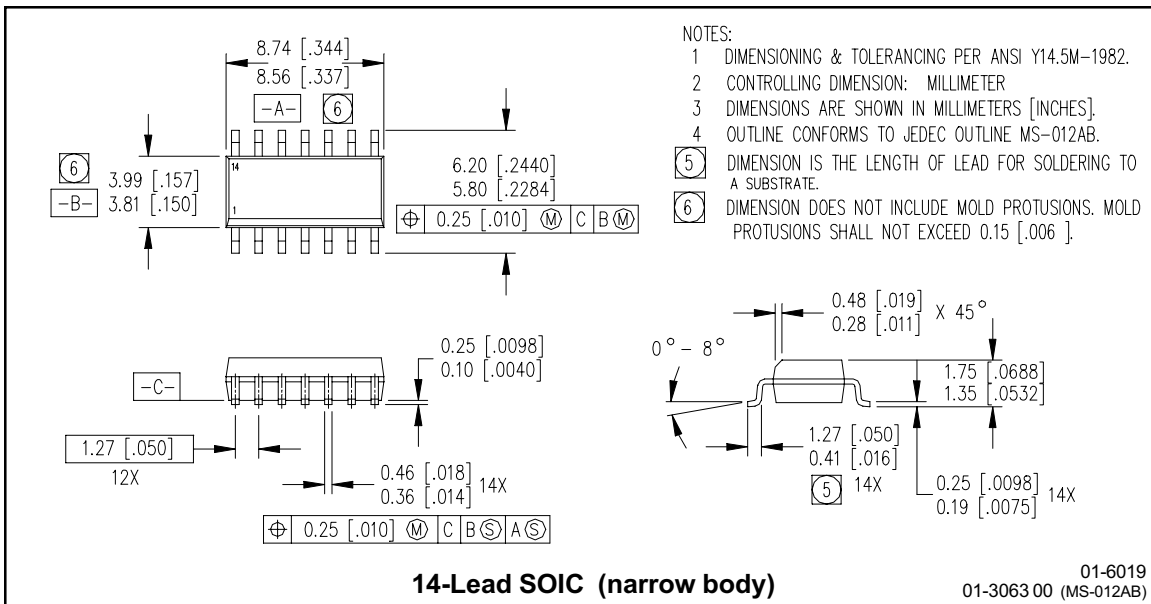
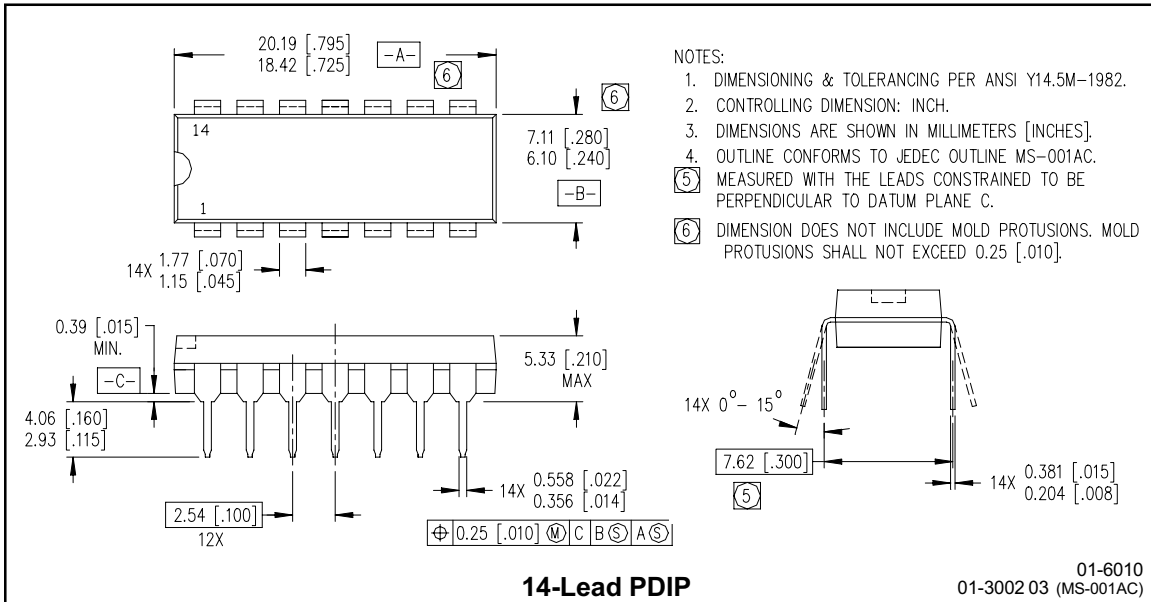


**Figure 37. IRS21834S vs. Frequency (IRFPE50),**  
 $R_{gate}=10 \Omega, V_{CC}=15 V$

## Case outlines

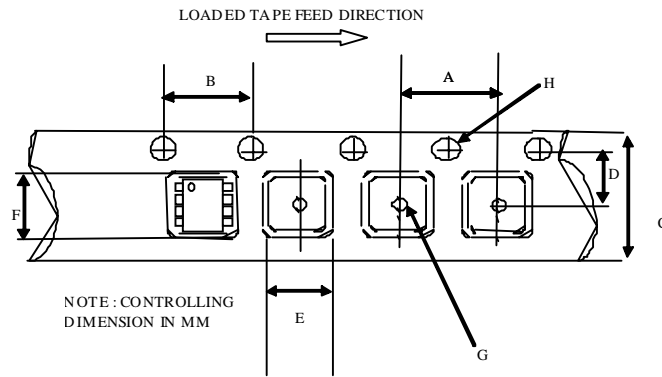


# IRS2183/IRS21834(S)PbF



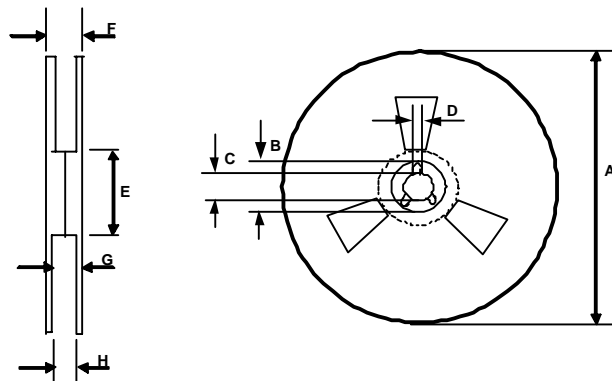
# IRS2183/IRS21834(S)PbF

## Tape & Reel 8-lead SOIC



CARRIER TAPE DIMENSION FOR 8SOICN

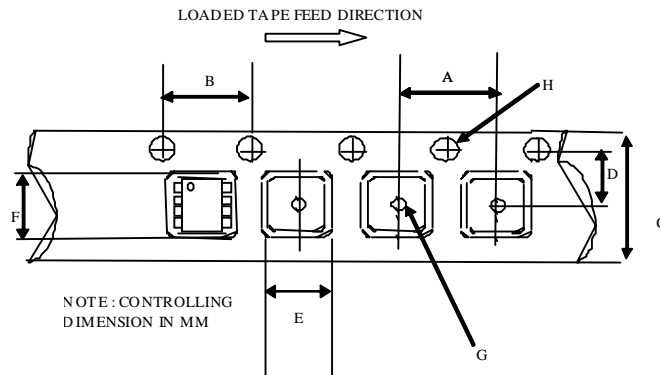
Code	Metric		Imperial	
	Min	Max	Min	Max
A	7.90	8.10	0.311	0.318
B	3.90	4.10	0.153	0.161
C	11.70	12.30	0.46	0.484
D	5.45	5.55	0.214	0.218
E	6.30	6.50	0.248	0.255
F	5.10	5.30	0.200	0.208
G	1.50	n/a	0.059	n/a
H	1.50	1.60	0.059	0.062



REEL DIMENSIONS FOR 8SOICN

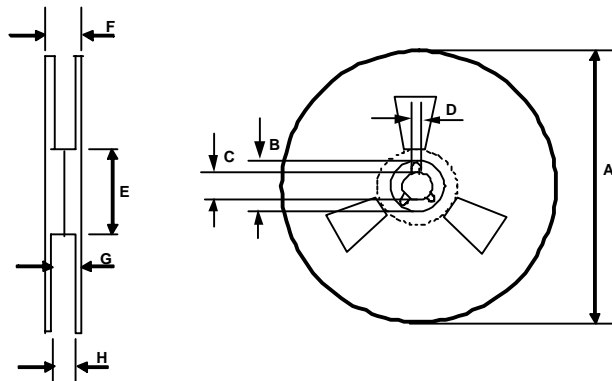
Code	Metric		Imperial	
	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
B	20.95	21.45	0.824	0.844
C	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	18.40	n/a	0.724
G	14.50	17.10	0.570	0.673
H	12.40	14.40	0.488	0.566

## Tape & Reel 14-lead SOIC



CARRIER TAPE DIMENSION FOR 14SOICN

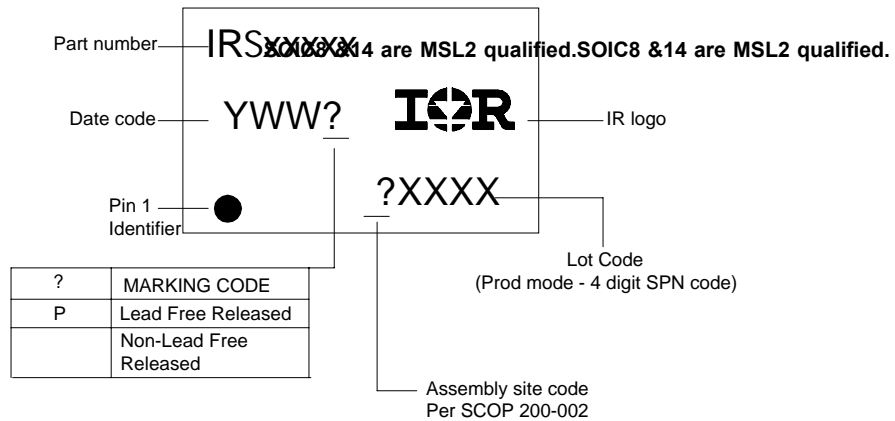
Code	Metric		Imperial	
	Min	Max	Min	Max
A	7.90	8.10	0.311	0.318
B	3.90	4.10	0.153	0.161
C	15.70	16.30	0.618	0.641
D	7.40	7.60	0.291	0.299
E	6.40	6.60	0.252	0.260
F	9.40	9.60	0.370	0.378
G	1.50	n/a	0.059	n/a
H	1.50	1.60	0.059	0.062



REEL DIMENSIONS FOR 14SOICN

Code	Metric		Imperial	
	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
B	20.95	21.45	0.824	0.844
C	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	22.40	n/a	0.881
G	18.50	21.10	0.728	0.830
H	16.40	18.40	0.645	0.724

## LEADFREE PART MARKING INFORMATION



## ORDER INFORMATION

8-Lead PDIP IRS2183PbF  
 8-Lead SOIC IRS2183SPbF  
 8-Lead SOIC Tape & Reel IRS2183STRPbF

14-Lead PDIP IRS21834PbF  
 14-Lead SOIC IRS21834SPbF  
 14-Lead SOIC Tape & Reel IRS21834STRPbF



Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)  
Email: [org@lifeelectronics.ru](mailto:org@lifeelectronics.ru)